

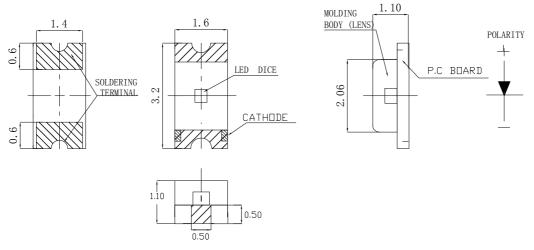
Features

- 3.2mm*1.6mm SMT LED, Super thin (1.10H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Product.

Applications

· Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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FSL-3216110Y-TCNHQ

Selection Guide

Part No	Lens Type	Dice	Emitted Color
FSL-3216110Y-TCNHQ	Water Clear	AlInGaP	Yellow

Electrical / Optical Characteristics At Ta=25°C

Parameter	Symbol	Min.	Тур.	Max. Unit		Test Condition
Iv	Luminous Intensity	45	72	288	mcd	IF=20mA
201/2	Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		588		nm	IF=20mA
入 d	Dominant Wavelength	586.5	589.5	595.5	nm	IF=20mA
Δλ	Spectral Line Half-Width		15		nm	IF=20mA
VF	Forward Voltage	1.7	2.2	2.6	V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

Absolute Maximum Ratings At Ta=25℃

Parameter	Yellow	Unit	
Power Dissipation	75	mW	
Peak Forward Current[1]	80	mA	
Continuous Forward Current	30	mA	
Derating Linear From 25 ℃	0.4	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	2000		
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to + 85°C		
Soldering Condition	260°C For 5 Seconds		

Note:

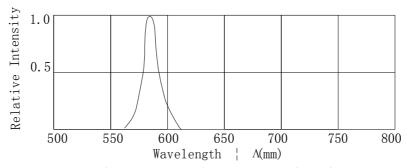
1. 1/10DutyCycle, 0.1msPulseWidth

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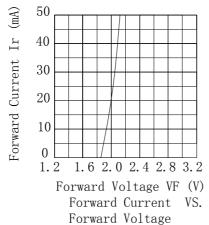
 $^{1.\,\}theta1/2$ is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

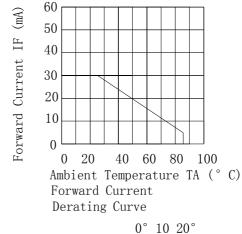


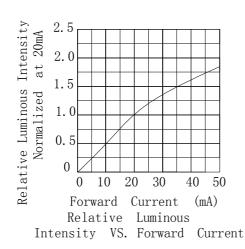
Electrical Optical Characteristics Curves At Ta=25°C

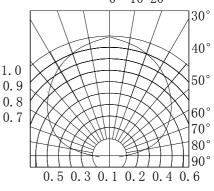


Rekative Intensity vs. Wavekength



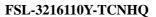






Spatial Distribution

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Bin Range Of Luminous Intensity

Symbol	Bin Code	Min.	Max.	Unit	Condition
	LL	45	72	mcd	IF=20mA
T	LM	72	112		
Iv	LN	112	180		
	LP	180	288		

Bin Range Of Forward Voltage

Symbol	Bin Code	Min.	Max.	Unit	Condition
	V2	1.7	2.0		
VF	V3	2.0	2.3	V	IF=20mA
	V4	2.2	2.6		

Bin Range Of Dominate Wavelength

Symbol	Bin Code	Min.	Max.	Unit	Condition
	J	586.5	589.5	nm	IF=20mA
入 d	K	589.5	592.5		
	L	592.5	595.5		

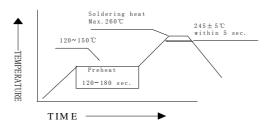
Notes:

- 1. Tolerance of Luminous Intensity +/-20 %
- 2. Tolerance of Forward Voltage $\pm -0.2V$
- 3. Tolerance of the Dominate Wavelength +/- 2nm

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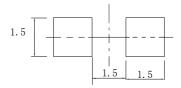
SMT Reflow Soldering Instructions



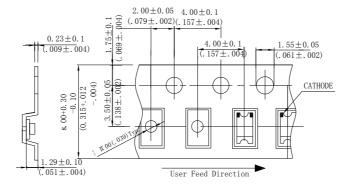
Notes:

- Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm (inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5\sim30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

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FSL-3216110Y-TCNHQ

Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
	Opertion Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
Hige Temperature High Humidity		Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	Hige Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C~±5°C~+85°C~±5°C 5min 10sec 5min	300 Cycles	0/20
Test Solder Resistance		Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	$V_F(V)$	IF=20mA	Over U×1.2
Rvevrse current	Ir(µA)	V _R =5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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